

SA.45s Space CSAC

Chip-Scale Atomic Clock



CSAC

Microsemi invented portable atomic timekeeping with the world's first family of miniature and chip scale atomic clocks.

Choose CSAC for best-in-class stability, size, weight, and power consumption.

Features

- Power consumption <120 mW
- Less than 17 cc volume, 1.6" × 1.39" × 0.45"
- Radiation-tolerant: 20 krad
- SEL, SEU tested to 64 MeV-cm²/mg (contact factory for details)
- 10 MHz CMOS-compatible output
- 1PPS output and 1PPS input for synchronization
- RS-232 interface for monitoring and control
- Short-term stability (Allan Deviation) of 3.0×10^{-10} at TAU = 1 sec

The Microsemi SA.45s Commercial Space Chip-Scale Atomic Clock's (CSAC) potential for low size, weight, and power (SWaP), and high timing performance at relatively low cost makes it very attractive for low Earth orbit (LEO) applications. In addition to being a stand-alone atomic clock with a 10 MHz output, the CSAC also has a 1PPS output and can be disciplined with a 1PPS input. The Space CSAC retains this functionality and is a timing module that can be disciplined with a GPS-derived 1PPS input.

The SA.45s provides 10 MHz and 1PPS outputs at standard CMOS levels, with short-term stability (Allan Deviation) of 3.0×10^{-10} at TAU = 1 sec, typical long-term aging of $<9 \times 10^{-10}$ /month, and maximum frequency change of $\pm 5 \times 10^{-10}$ over an operating temperature range of -10°C to 70°C .

A standard CMOS-level RS-232 serial interface is built into the SA.45s. This is used to control and calibrate the unit and to provide a comprehensive set of status monitors. The interface is also used to set and read the CSAC's internal time-of-day clock.

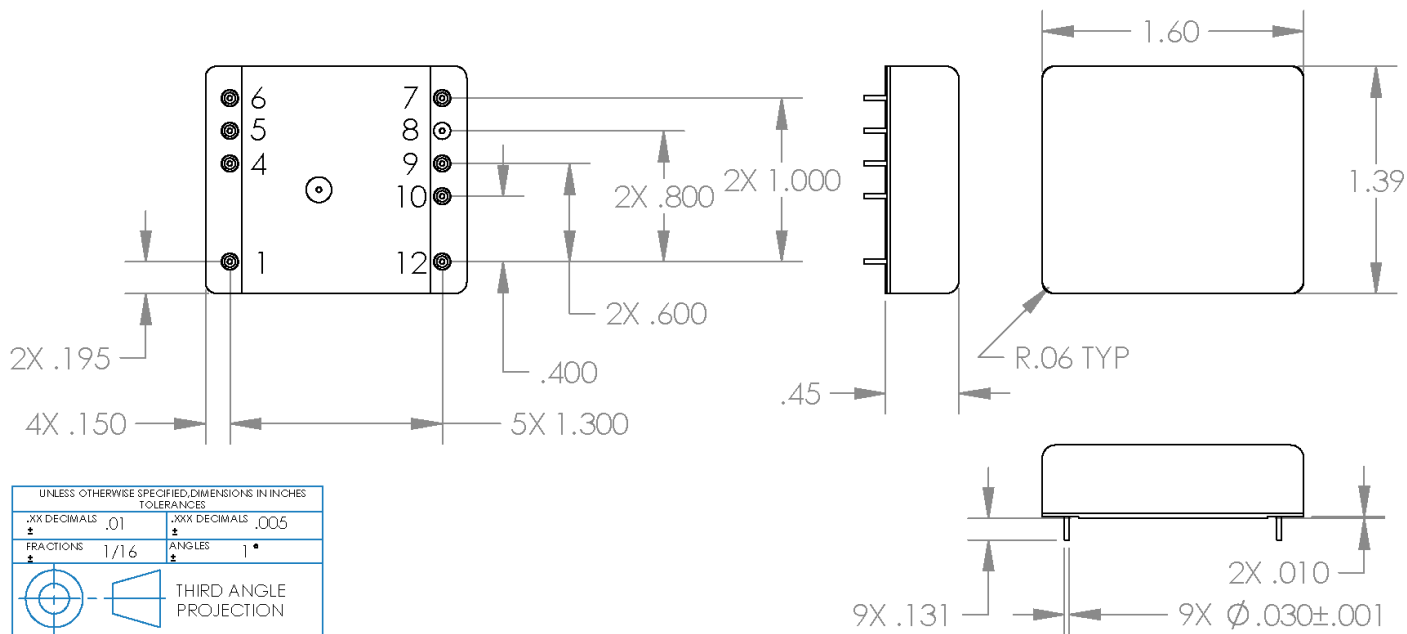
Applications

- Satellite timing and frequency control
- Satellite clock reference
- Assured position, navigation, and timing (PNT)
- Atomic clock accuracy
- Satellite cross-linking

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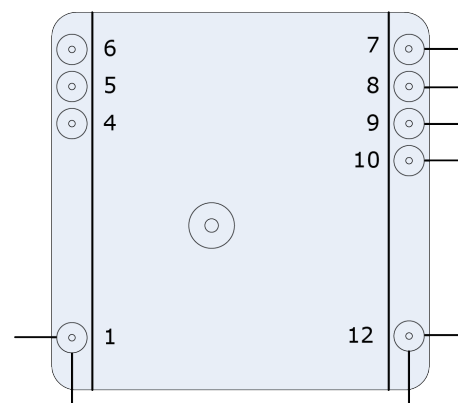
Mechanical Interface



Pin Description

Pin Number	ID
1	Tune
2	N/A
3	N/A
4	BITE
5	Tx
6	Rx
7	V _{cc}
8	GND
9	1 PPS IN
10	1 PPS OUT
11	N/A
12	10 MHz OUT

Bottom View



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Specifications¹

Electrical

RF Output

- Frequency 10 MHz
- Format CMOS
- Amplitude 0 V to V_{CC}
- Load impedance 1 MΩ
- Quantity 1

1PPS Output

- Rise/fall time (10%–90%) at load capacitance 10 pF <10 ns
- Pulse width 100 μs
- Level 0 V to V_{CC}
- Logic high (V_{OH}) min 2.80 V
- Logic low (V_{OL}) max 0.30 V
- Load impedance 1 MΩ
- Quantity 1

1PPS Input

- Format Rising edge
- Low level <0.5 V
- High level 2.5 V to V_{CC}
- Input impedance 1 MΩ
- Quantity 1

Serial Communications

- Protocol RS232
- Format CMOS 0 V to V_{CC}
- Tx/Rx impedance 1 MΩ
- Baud rate 57600

Built-In Test Equipment (BITE) Output

- Format CMOS 0 V to V_{CC}
- Load impedance 1 MΩ
- Logic 0= Normal operation
1= Alarm

Power Input

- Operating <120 mW
- Warmup <140 mW
- Input voltage (V_{CC}) 3.3 ± 0.1 V_{DC}

Environmental

- Operating temperature –10 °C to 70 °C
- Maximum frequency change over operating temp range (maximum rate of change 0.5 °C per minute) ±5 × 10⁻¹⁰
- Magnetic sensitivity (≤2.0 Gauss) ±9 × 10⁻¹¹/Gauss
- Radiated emissions Compliant to FCC part 15, Class B, when mounted properly onto host PCB
- Vibration Maintains lock under MIL-STD-810, Method 514.5, Procedure 1, 7.7 g_{rms}
- Humidity 0%–95% RH per MIL-STD-810, Method 507.4

Storage and Transport (Non-operating)

- Temperature –55 °C to 85 °C
- Vibration MIL-STD-810, Method 514.5, Procedure 1, 7.7 g_{rms}
- Shock (1 ms half-sine) 1000 g

Performance Parameters

- Warm-up time <180 s
- Analog tuning Range: ±2.2 × 10⁻⁸
Resolution: 1 × 10⁻¹¹
Input: 0 V–2.5 V into 100 kΩ
- Digital tuning Range: ±1 × 10⁻⁶
Resolution: 1 × 10⁻¹²

Phase Noise (SSB)

Frequency	CSAC
1 Hz	<–50 dBc/Hz
10 Hz	<–70 dBc/Hz
100 Hz	<–113 dBc/Hz
1 kHz	<–128 dBc/Hz
10 kHz	<–135 dBc/Hz
100 kHz	<–140 dBc/Hz

Frequency Accuracy

- Maximum offset at shipment ±5 × 10⁻¹¹
- Maximum retrace (48 hrs off) ±5 × 10⁻¹⁰
- 1 PPS sync ±100 ns

¹At input voltage V_{CC} = 3.3 V_{DC} and ambient temperature = 25 °C, unless otherwise specified.

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Aging

Type ²	SA.45s ³
Monthly	$<9 \times 10^{-10}$
Yearly	$<1 \times 10^{-8}$

²After 30 days of continuous operation.

³All CSAC units are tested for aging specs as per the datasheet and meet the specs at the time of shipment. However, continuous operation of CSAC over extended period of time may yield unpredictable aging performance, resulting in failure to meet the aging specs and may not be suitable for certain applications.

Short-Term Stability (Allan Deviation)

Type	SA.45s
$\tau = 1 \text{ s}$	3×10^{-10}
$\tau = 10 \text{ s}$	1×10^{-10}
$\tau = 100 \text{ s}$	3×10^{-11}
$\tau = 1000 \text{ s}$	1×10^{-11}

Radiation Tolerance

Type	SA.45s
TID	20 krad, $<5 \times 10^{-10}$ frequency offset change
SEL, SEU	Tested to 64 MeV-cm ² /mg (contact factory for details)

Physical

- Weight $<35 \text{ g}$ ($<1.23 \text{ oz}$)
- Size $1.6" \times 1.39" \times 0.45"$
- MTBF $>100,000 \text{ hours}$

Solder

Hand solder using 63/37 tin/lead solder with maximum soldering tip of 329 °C (625 °F).

Ordering Information

Part Number	Description	Output Frequency
090-02984-007	Space chip-scale atomic clock	10 MHz



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